

STL15N3LLH5

N-channel 30 V, 0.0045 Ω, 15 A, PowerFLAT™ (3.3 x 3.3) STripFET™ V Power MOSFET

Preliminary Data

Features

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Туре	Type V _{DSS} R _{DS(on)}		I _D
STL15N3LLH5	30V	<0.0054Ω	15A ⁽¹⁾

- 1. The value is rated according Rthj-pcb
- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses



Switching applications

Description

This product utilizes the 5th generation of design rules of ST's proprietary STripFETTM technology. The lowest available $R_{DS(on)}^*Q_g$, in this chip scale package, makes this device suitable for the most demanding DC-DC converter applications, where high power density is to be achieved.

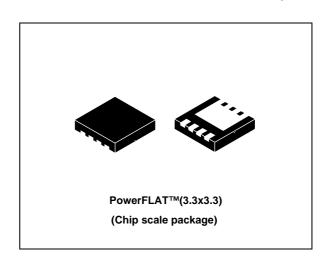


Figure 1. Internal schematic diagram

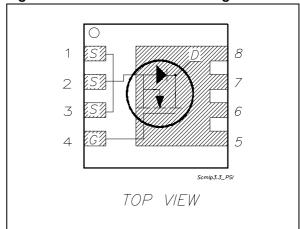


Table 1. Device summary

Order code	Marking	Package	Packaging
STL15N3LLH5	15N3LLH5	PowerFLAT™ (3.3 x 3.3)	Tape and reel

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STL15N3LLH5 Electrical ratings

1 Electrical ratings

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Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate-source voltage	± 22	٧
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	15	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C =100 °C	9.3	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	60	Α
P _{TOT} ⁽³⁾	Total dissipation at T _C = 25 °C	50	W
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25 °C	2	W
	Derating factor	0.4	W/°C
T _J T _{stg}	Operating junction temperature storage temperature	-55 to 150	°C

^{1.} The value is rated according Rthj-pcb

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case (drain)	2.5	°C/W
R _{thj-pcb} (1)	Thermal resistance junction-pcb	42.8	°C/W
R _{thj-pcb} (2)	Thermal resistance junction-pcb	63.5	°C/W

^{1.} When mounted on FR-4 board of 1inch 2 , 2oz Cu, t < 10sec

^{2.} Pulse width limited by safe operating area.

^{3.} The vaule is rated according Rthj-c

^{2.} Steady state

Electrical characteristics STL15N3LLH5

2 Electrical characteristics

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(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating @125 °C			1 10	μA μA
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 22 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	V
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10 V, I_{D} = 7.5 A V_{GS} = 4.5 V, I_{D} = 7.5 A		0.0045 0.006	0.0054 0.0075	Ω Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25 V, f=1 MHz, V _{GS} =0		1500 295 39		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =15 V, I_D = 15 A V_{GS} =4.5 V (see Figure 3)		12 4 4.7		nC nC nC
R _G	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20 mV Open drain	0.5	1.5	2.5	Ω

Table 6. Switching times

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f}$	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I_{D} = 7.5 A, R_{G} =4.7 Ω , V_{GS} =4.5 V (see Figure 2)		9.3 14.5 22.7 4.5		ns ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current				15	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				60	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} =15 A, V _{GS} =0			1.1	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =15 A, di/dt = 100 A/ μ s, V_{DD} =20 V, Tj=150 °C (see Figure 7)		25 17.5 1.4		ns nC A

^{1.} Pulse width limited by safe operating area

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^{2.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Test circuit STL15N3LLH5

3 Test circuit

Figure 2. Switching times test circuit for resistive load

Figure 3. Gate charge test circuit

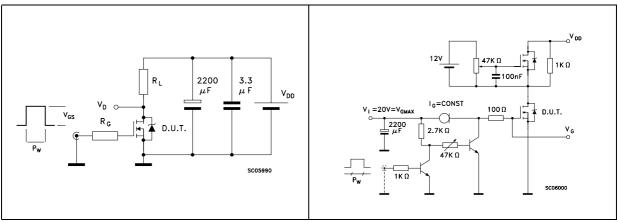


Figure 4. Test circuit for inductive load switching and diode recovery times

Figure 5. Unclamped inductive load test circuit

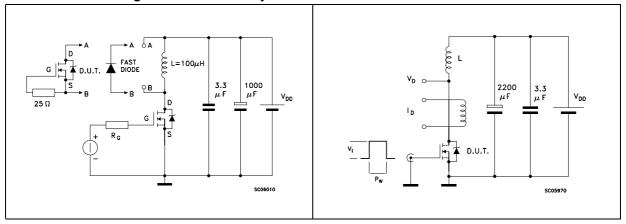
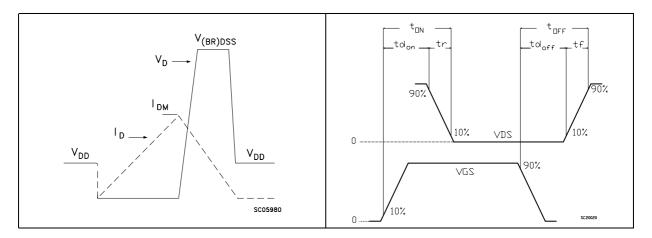


Figure 6. Unclamped inductive waveform

Figure 7. Switching time waveform



4 Package mechanical data

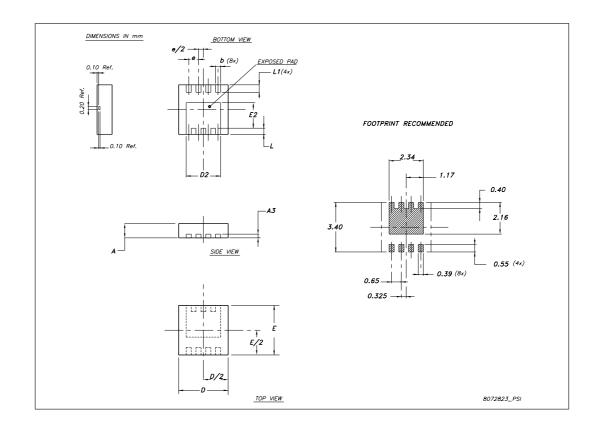
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In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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PowerFLAT™ (3.3 x 3.3) mechanical data

Dive	Dim				inch	
Dilli	Min	Тур	Max	Min	Тур	Max
Α	0.950		1.000	0.037		0.039
A3		0.200			0.008	
b	0.29	0.34	0.39	0.011	0.013	0.015
D	3.200	3.300	3.400	0.126	0.123	0.134
D2	2.24	2.29	2.34	0.088	0.090	0.092
E	2.20	3.30	3.40	0.086	0.123	0.1338
E2	1.660	1.710	1.760	0.065	0.067	0.069
е		0.650			0.025	
L		0.40			0.0157	
L1	0.45	0.50	0.55	0.017	0.0196	0.021



STL15N3LLH5 Revision history

5 Revision history

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Table 8. Document revision history

Date	Revision	Changes
25-Aug-2008	1	First release

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